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CENTRAL FAX CENTER****NOV 26 2010****Pat. No. 6,940,053****PATENT****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Song-Hua Shi

Docket: P17611

Patent No.: 6,940,053

Issued: September 6, 2005

Title: CHIP BONDING HEATER WITH DIFFERENTIAL HEAT TRANSFER

**REVOCATION AND POWER OF ATTORNEY****CERTIFICATE UNDER 37 CFR § 3.73(b)**Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

In accordance with 37 C.F.R. Section 1.36, M.P.E.P. Section 402.05 and 402.07, please revoke any existing Powers of Attorney, if any, and appoint the following attorneys and/or patent agents to prosecute this application and to transact all business in the Patent and Trademark Office in connection therewith:

**Customer Number: 59796****CERTIFICATE UNDER 37 CFR § 3.73(b)**

Intel Corporation hereby certifies that it is the assignee of the entire right, title and interest in the patent application identified above by virtue of an assignment from the inventor filed November 18, 2003 and recorded on Reel 014730 Frame 0323. To the best of my knowledge and belief, title is in Intel Corporation, the assignee.

Pursuant to 37 C.F.R. § 3.73(b) I hereby declare that I, Pam J. Matlock, am empowered to sign this certificate on behalf of Intel Corporation, the assignee.

I hereby declare that all statement made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true.

Please direct all correspondence in this case to:

**Laleh Jalali  
c/o CPA Global  
Customer Number: 59796**

Date

November 8, 2010

By

Pam MatlockPam J. Matlock  
Secretary of Patents,  
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